

Product Change Notification / JAON-19SJPJ307

Date:

25-May-2021

Product Category:

32-bit Microcontrollers

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4398.001 Final Notice: Qualification of MMT as an additional assembly site for selected Atmel ATSAML10D1xA, ATSAML11D1xA, ATSAMD11D14A, ATSAMD10D1xA, ATSAMD09D14A and ATMPS001D14A device families available in 24L VQFN (4x4x0.9mm) package.

Affected CPNs:

JAON-19SJPJ307_Affected_CPN_05252021.pdf JAON-19SJPJ307_Affected_CPN_05252021.csv

Notification Text:

PCN Status: Final notification

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open one of the files found in the Affected CPNs section.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:Qualification of MMT as an additional assembly site for selected Atmel ATSAML10D1xA, ATSAML11D1xA, ATSAMD11D14A, ATSAMD10D1xA, ATSAMD09D14A and ATMPS001D14A device families available in 24L VQFN (4x4x0.9mm) package.

Pre and Post Change Summary:*For ATSAML10D1xA and ATSAML11D1xA device families:*

	Pre Change	Post	t Change			
Assembly Site	ASE Group Chung-Li (ASCL)	ASE Group Chung-Li (ASCL)	Microchip Technology Thailand			
Wire material	CuPdAu	CuPdAu	(Branch) (MMT) Au			
Die attach material	ATB-125	ATB-125	8006NS			
Molding compound material	G700	G700	G700			
Lead frame material	C194	C194	C194			
Lead frame DAP surface prep	Double Ag Ring Plated	Double Ag Ring Plated	Ag selective plated			
	No	No	Yes			
Lead frame lead lock	See pre and post change comparison					

For ATSAMD11D14A, ATSAMD10D1xA, ATSAMD09D14A and ATMPS001D14A device families:

	Pre Change	Pos	Post Change			
Assembly Site	ASE Inc. (ASE)	ASE Inc. (ASE)	Microchip Technology Thailand			
			(Branch) (MMT)			
Wire material	CuPdAu	CuPdAu	Au			
Die attach material	NEX-130CTX	NEX-130CTX	8006NS			
Molding compound material	G631H	G631H	G700			
Lead frame material	C194	C194	C194			
Lead frame paddle size	110x110	110x110	114x114			
Lead frame DAP surface prep	Ag plated	Ag plated	Ag selective plated			
Lood from a lood look	No	No	Yes			
Lead frame lead lock	See pre and post change comparison					
MSL Classification	MSL 3	MSL 3 MSL 3 MSL 1				

Impacts to Data Sheet: Yes. Package Outline Drawing (POD)

		ASCL / ASE 24L VQFN-WFS 4x4			MMT 24L VQFN-WFS 4x4			
Feature	Dimension	MIN	NOM	MAX	MIN	NOM	MAX	
Number of Pins	n	24			24			
Pitch	е	0.50 REF			0.50 BSC			
Overall Height	А	0.80	0.85	0.90	0.80	0.90	1.00	
Standoff	A1	0.00	-	0.05	0.00		0.05	
Terminal Thickness	A3	0.203 REF			0.203 REF			
Overall Width	D	3.90	4.00	4.10	3.90	4.00	4.10	
Exposed Pad Width	D2	2.55	2.60	2.65	2.55	2.60	2.65	
Overall Length	E	3.90	4.00	4.10	3.90	4.00	4.10	
Exposed Pad Length	E2	2.55	2.60	2.65	2.55	2.60	2.65	
Terminal Width	b	0.20	0.25	0.30	0.20	0.25	0.30	

Terminal Length	L	0.35	0.40	0.45	0.35	0.40	0.45
Contact-to-Exposed Pad	К	0.20	-	-		0.30 REF	

Change Impact:None

Reason for Change: To improve on-time delivery performance by qualifying MMT as an additional assembly site.

Change Implementation Status: In Progress

Estimated First Ship Date: May 28, 2021 (date code: 2122)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	May 2021				
Workweek	1	2	2	2	2
	9	0	1	2	3
Qual Report Availability				Х	
Final PCN Issue Date				Х	
Estimated First Ship Date				Х	

Method to Identify Change: Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History:May 25, 2021: Issued final notification. Attached the qualification report. Provided estimated first ship date to be on May 28, 2021.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_JAON-19SJPJ307_Qual_Report.pdf PCN_JAON-19SJPJ307_Pre and Post Change_Summary.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

ATSAML10D14A-MF ATSAML10D15A-MF ATSAML10D16A-MF ATSAML11D14A-MF ATSAML11D15A-MFKPH ATSAML11D15A-MF ATSAML11D16A-MFKPH ATSAML11D16A-MF ATSAML10D14A-MU ATSAML10D15A-MU ATSAML10D16A-MU ATSAML11D14A-MU ATSAML11D15A-MUKPH ATSAML11D15A-MU ATSAML11D16A-MUKPH ATSAML11D16A-MU ATSAML10D14A-MUT ATSAML10D15A-MUT ATSAML10D16A-MUT ATSAML11D14A-MUT ATSAML11D15A-MUTKPH ATSAML11D15A-MUT ATSAML11D16A-MUTKPH ATSAML11D16A-MUT ATSAML10D14A-MFT ATSAML10D15A-MFT ATSAML10D16A-MFT ATSAML11D14A-MFT ATSAML11D15A-MFTKPH ATSAML11D15A-MFT ATSAML11D16A-MFTKPH ATSAML11D16A-MFT ATSAMD11D14A-MU ATSAMD10D13A-MNT ATSAMD10D14A-MNT ATSAMD11D14A-MNT ATSAMD11D14A-MUT ATSAMD10D14A-MUT ATSAMD10D13A-MUT ATSAMD09D14A-MUT ATSAMD10D14A-MUTB5 ATMPS001D14A-MUT ATMPS001D14A-MUTA01 NI32D14-MUT ATSAMD11D14A-MUTN03